IPC ASSOCIATION ELECTRONIE	© Copyright 200:	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under be international and Pan-American copyright conventions.		nder both	This docume level parts, th	nt is a declarati ne declaration e	on of the	substances ses all lower	within the manu- level materials	facturer liste for which the	d item. Note: e manufacture	of the item is an as r has engineering	ssembly with low responsibility.		
752-21.1		IPC Web Site for Information on IPC-1752 Standard http://www.ipc.org/IPC-175x Form Typ Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					laterials and	ials and Mfg Information			
Supplie	r Information														
Company name* Company un				nique ID [t			Unique ID Authority				Respo	Response Date*			
nsemi											2023-	2023-06-08			
Contact N	lame		Title - Conta	Title - Contact			Phone - Contact*				Emai	Email - Contact*			
Product-	Env-Stewards		Product Enviro Compliance			1	NA				Prod	Product-Env-Stewards@onsemi.com			
uthorize	ed Representative*		Title - Representative			I	Phone - Representative*			Emai	Email - Representative*				
Product-	Env-Stewards		Product Enviro Compliance			1	NA				Prod	Product-Env-Stewards@onsemi.com			
	Requester Item Number Mfr Item		n Number Mfr Item Name				Effective Date Version Manufacturing S		te	Weight*	UOM	Unit Type			
		NCP612SQ37T2G ACMOS1 LDO RE		EGULATOR		2023-06-08	MY1			6.2	mg	Each			
Ianufa	ecturing Process Inform												·	·	
	3				-STD-020 MSL	Rating	Peak Process Body Temperatu			e Max Time at	Peak Tempe	rature Num	per of Reflow Cyc	cles	
Matte Tin (Sn) - annealed			CU Alloy	1			260		C	30	sec	conds 3			
omments															
vel 1 - m	naximum time at peak temper	ature during so	ldering is 10-	30 seconds											
or more	information regarding mater	ial composition	please refer t	o page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information is true and corrections that such information is true and corrections that such information is true and corrections. Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier has not or written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the w											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.19 mg Supplier Silicon (Si)		7440-21-3		0.19	mg		
Die Attach	0.12	mg	Supplier	Epoxized Condensate Of Para- Hydrobenzaldehyde And Alkyl Phenol	129915-35-1		0.078	mg
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		0.042	mg
Lead Frame	1.92		Supplier	Silver (Ag)	7440-22-4		0.0384	mg
			В	Nickel (Ni)	7440-02-0		0.697	mg
			Supplier	Iron (Fe)	7439-89-6		0.9638	mg
			Supplier	Copper (Cu)	7440-50-8		0.2208	mg
Mold Compound-Black	3.9			Epoxy resin	proprietary data		0.195	mg
			Supplier	Phenolic Resin	Proprietary Data		0.195	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.078	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0195	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		3.4125	mg
Plating	0.05	mg	Supplier	Tin (Sn)	7440-31-5		0.05	mg
Wire Bond - Au	0.02	mg	Supplier	Gold (Au)	7440-57-5		0.02	mg